

09-14-1999



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RECORDATION FORM COVER SHEET



Docket: 0819-276

mtD
9-2-99

To the Honorable Assistant Commissioner for Patent. Please record the attached original documents or copy thereof.

1. Name of conveying parties: Kenji ORITA, Masahiro ISHIDA, Shinji NAKAMURA, Masaaki YURI

Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

2. Name and address of receiving party:

Name: Matsushita Electronics Corporation

Street Address: 1-1, Saiwai-cho, Takatsuki-shi, Osaka 569-1193, Japan

City _____ State _____ ZIP _____

Additional name(s) & addresses(es) attached? ☐ Yes ☒ No

3. Name of Conveyance:

☒ Assignment

☐ Merger

☐ Security Agreement

☐ Change of Name

☐ Other _____

Execution Date: August 30, 1999

4. Application number(s) or patent number(s):

09/389024

If this document is being filed together with a new application, the execution date of the application is: August 30, 1999

Title: METHOD FOR FABRICATING SEMICONDUCTOR DEVICE

A: Patent Application No.(s)

B. Patent No.(s)

Additional numbers attached? ☐ Yes ☐ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: SIXBEY, FRIEDMAN, LEEDOM & FERGUSON, P.C.

Street Address: 8180 Greensboro Drive, Suite 800

City: McLean State: Virginia ZIP 22102

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 3.41):\$40.00

☒ Enclosed

☐ Authorized to be changed to deposit account

8. Deposit Account Number: _____

(Attach duplicate copy of this page if paying by deposit account)

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02 FC:581 Statement and signature. 40.00

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Eric J. Robinson

Name of Person Signing

Signature

9-2-99
Date

Total number of pages including cover sheet, attachments, and document: 3

ASSIGNMENT

WHEREAS, Kenji ORITA, Masahiro ISHIDA, Shinji NAKAMURA, Masaaki YURI
_____ (hereinafter designated as the undersigned) has (have) invented certain new and
useful improvements in METHOD FOR FABRICATING SEMICONDUCTOR DEVICE

for which an application for Letters Patent of the United States of America has been executed by
the undersigned on August 30, 1999, and;

WHEREAS, Matsushita Electronics Corporation of
1-1, Saiwai-cho, Takatsuki-shi, Osaka 569-1193, Japan
its heirs, successors, legal representatives and assigns (hereinafter designated as the Assignee)
is desirous of acquiring the entire right, title and interest in and to said invention and in and to
any Letters Patent(s) that may be granted therefor in the United States of America;

NOW, THEREFORE, in consideration of the sum of One Dollar (\$1.00) to the
undersigned in hand paid, the receipt of which is hereby acknowledged, and other good and
valuable consideration, the undersigned has (have) sold, assigned and transferred, and by these
presents do sell, assign and transfer unto said Assignee the full and exclusive right to the said
invention in the United States of America and its territories and for all foreign countries,
dependencies and possessions and the entire right, title and interest in and to any and all Letters
Patent(s) which may be granted therefor in the United States of America and its territories,
dependencies and possessions, and in and to any and all divisions, reissues, continuations and
extensions thereof for the full term or terms for which the same may be granted.

The undersigned agree(s) to execute all papers necessary in connection with this
application and any continuing, divisional or reissue applications thereof and also to execute
separate assignments in connection with such applications as the Assignee may deem necessary
or expedient.

The undersigned agree(s) to execute all papers necessary in connection with any
interference which may be declared concerning this application or any continuation, division or
reissue thereof or Letters Patent(s) or reissue patent issued thereon and to cooperate with the
Assignee in every way possible in obtaining and producing evidence and proceeding with such
interference.

The undersigned agree(s) to execute all papers and documents and to perform any act
which may be necessary in connection with claims under or provisions of the International
Convention for the Protection of Industrial Property or similar agreements.

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent(s) to the Assignee and to vest all rights therein hereby conveyed to said Assignee as fully and entirely as the same would have been held by the undersigned if this Assignment and sale had not been made.

The undersigned hereby authorize(s) and request(s) the Commissioner of Patents and Trademarks to issue any and all Letters Patents of the United States of America resulting from said application or any division or divisions or continuing or reissue applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) the full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

The undersigned hereby grant(s) the law firm of Sixbey, Friedman, Leedom & Ferguson, P.C. the power to insert on this Assignment any further identification which may be necessary or desirable in order to comply with the rules of the U.S. Patent and Trademark Office for recordation of this document.

In witness thereof, this Assignment has been executed by the undersigned on the date(s) opposite the undersigned name(s).

Date August 30, 1999, Name of Inventor Kenji Orita (SEAL)
Kenji ORITA

Date August 30, 1999, Name of Inventor Masahiro Ishida (SEAL)
Masahiro ISHIDA

Date August 30, 1999, Name of Inventor Shinji Nakamura (SEAL)
Shinji NAKAMURA

Date August 30, 1999, Name of Inventor Masaaki Yuri (SEAL)
Masaaki YURI

Date _____, Name of Inventor _____ (SEAL)

(This assignment should preferably be acknowledged before a United States Consul or Notary Public. If not, then the execution by the Inventor(s) should be witnessed by at least two other persons who should sign here.)

Witness Kunio ITOH
(name)

Kunio Itoh
(signature)

Witness Nobuyuki UEMURA
(name)

Nobuyuki Uemura
(signature)